MOSFET – Power, N-Channel, SUPERFET[®] III

800 V, 600 mΩ, 8 A

NTD600N80S3Z

Description

800 V SUPERFET III MOSFET is ON Semiconductor's high performance MOSFET family offering 800 V breakdown voltage.

New 800 V SUPERFET III MOSFET which is optimized for primary switch of flyback converter, enables lower switching losses and case temperature without sacrificing EMI performance thanks to its optimized design. In addition, internal Zener Diode significantly improves ESD capability.

This new family of 800 V SUPERFET III MOSFET enables to make more efficient, compact, cooler and more robust applications because of its remarkable performance in switching power applications such as Laptop adapter, Audio, Lighting, ATX power and industrial power supplies.

Features

- Typ. $R_{DS(on)} = 550 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 15.5 nC)
- Low Stored Energy in Output Capacitance (Eoss = 1.74 µJ @ 400 V)
- 100% Avalanche Tested
- ESD Improved Capability with Zener Diode
- RoHS Compliant

Applications

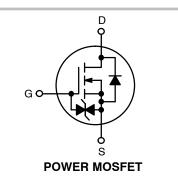
- Adapters / Chargers
- LED Lighting
- AUX Power
- Audio
- Industrial Power



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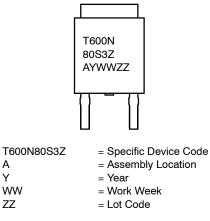
www.onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX		
800 V	600 mΩ	8 A		









ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Par	Value	Unit	
V _{DSS}	Drain-to-Source Voltage		800	V
V _{GS}	Gate-to-Source Voltage	DC	±20	V
		AC (f > 1 Hz)	±30	
Ι _D	Drain Current	Continuous (T _C = 25°C)	8*	А
		Continuous (T _C = 100°C)	5*	
I _{DM}	Drain Current	Pulsed (Note 1)	21*	А
E _{AS}	Single Pulsed Avalanche Energy (No	24	mJ	
I _{AS}	Avalanche Current (Note 2)		1.2	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		0.6	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		10	
PD	Power Dissipation	(T _C = 25°C)	60	W
		Derate Above 25°C	0.48	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to +150	°C
ΤL	Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from Case for 10 seconds)		260	°C

ABSOLUTE MAXIMUM RATINGS (T_J = 25°C, unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
*Drain current limited by maximum junction temperature.
1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. I_{AS} = 1.2 A, R_G = 25 Ω, starting T_J = 25°C.
3. I_{SD} ≤ 2 A, di/dt ≤ 200 A/µs, V_{DD} ≤ 400 V, starting T_J = 25°C.

THERMAL RESISTANCE RATINGS

Symbol	Parameter	Value	Unit
$R_{ extsf{ heta}JC}$	Junction-to-Case - Steady State	2.08	°C/W
R_{\thetaJA}			

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Quantity
NTD600N80S3Z	NTD600N80S3Z	TO-252	330 mm	16 mm	2500 Units

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

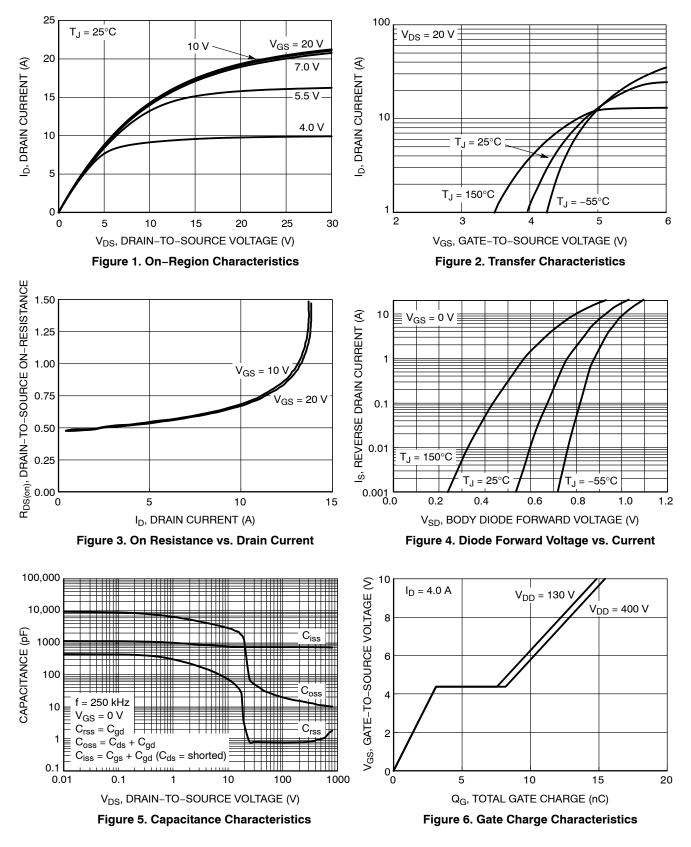
Symbol	Parameter	Parameter Test Conditions		Тур	Max	Unit
OFF CHARACI	TERISTICS	•			•	
BV _{DSS}	Drain-to-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	800			V
		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C	900			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Drain-to-Source Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$		1.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ
		V_{DS} = 640 V, T_{C} = 125°C		0.8		
I _{GSS}	Gate-to-Body Leakage Current	V_{GS} = ± 20 V, V_{DS} = 0 V			1	μA
ON CHARACTE	ERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 0.18 \text{ mA}$	2.2		3.8	V
R _{DS(on)}	Static Drain-to-Source On Resistance	V _{GS} = 10 V, I _D = 4 A		550	600	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 4 \text{ A}$		9.4		S
YNAMIC CHA	RACTERISTICS	•		•		
Ciss	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 250 kHz		725		pF
Coss	Output Capacitance	-		12		pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		139		pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		21		pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 4 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$ (Note 4)		15.5		nC
Q _{gs}	Gate-to-Source Gate Charge			3.1		nC
Q _{gd}	Gate-to-Drain "Miller" Charge			5.1		nC
ESR	Equivalent Series Resistance	f = 1 MHz		3.5		Ω
WITCHING CH	HARACTERISTICS					-
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 4 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$		12.3		ns
t _r	Turn-On Rise Time	$R_g = 4.7 \Omega$ (Note 4)		5.9		ns
t _{d(off)}	Turn-Off Delay Time			39.5		ns
t _f	Turn-Off Fall Time			8.2		ns
SOURCE-TO-I	DRAIN DIODE CHARACTERISTICS			-	-	-
۱ _S	Maximum Continuous Source-to-Drain Diode Forward Current				8	Α
I _{SM}	Maximum Pulsed Source-to-Drain Diode Forward Current				21	Α
V _{SD}	Source-to-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 4 A$			1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 2 A,$		137		ns
Q _{rr}	Reverse Recovery Charge	— dI _F /dt = 100 A/μs		0.91	1	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

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TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

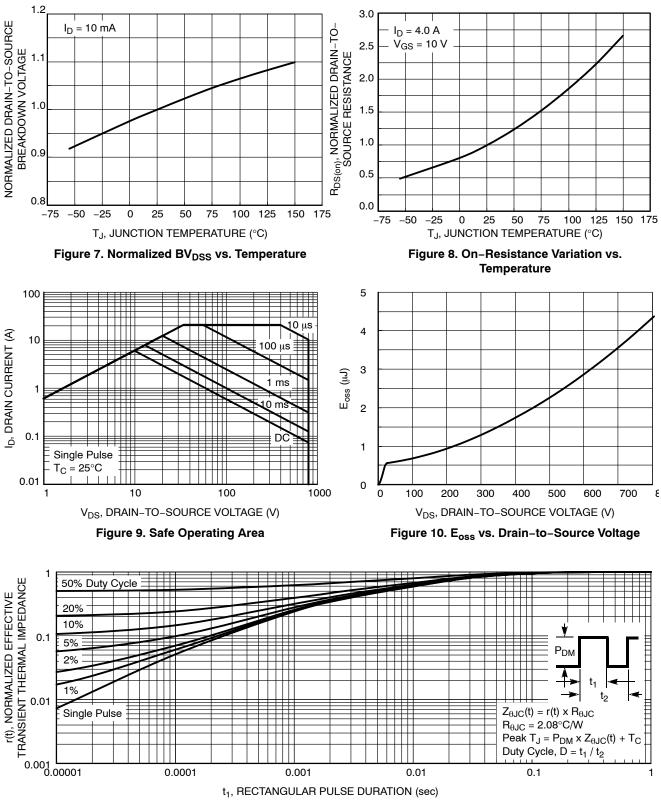


Figure 11. Transient Thermal Impedance

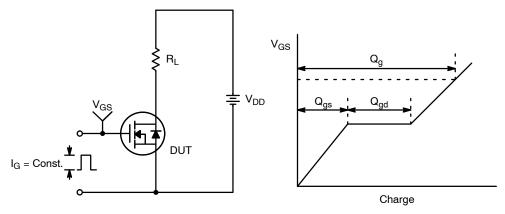


Figure 12. Gate Charge Test Circuit & Waveform

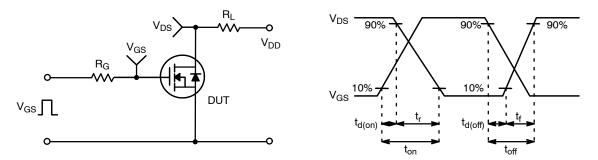


Figure 13. Resistive Switching Test Circuit & Waveforms

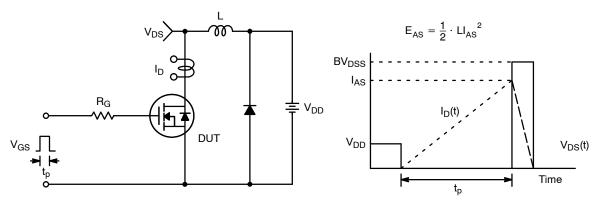


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

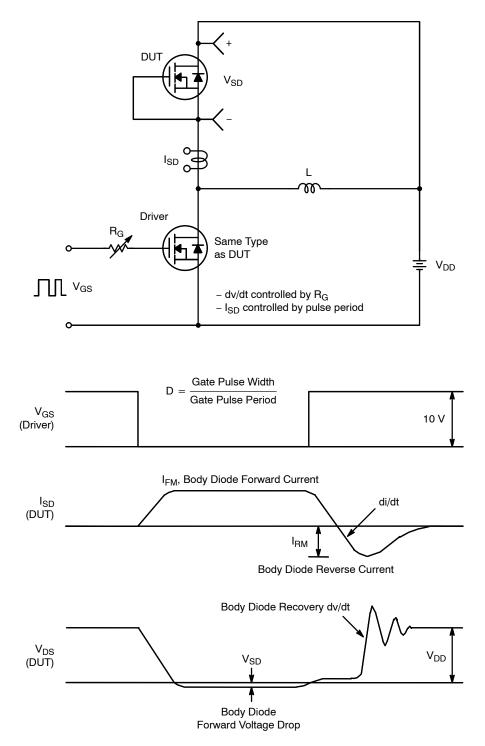
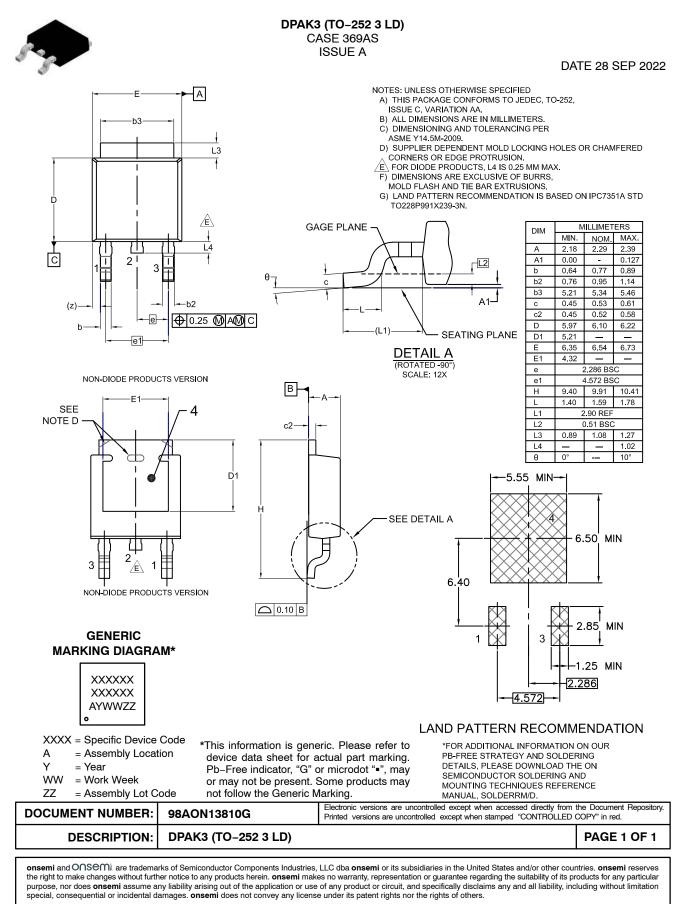


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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